

Appl. No. 10/706,392
Amdt. dated May 18, 2005
Reply to Office action of February 18, 2005

This listing of claims will replace all prior versions, and listings, of claims in the application:

Listing of Claims:

1. (Currently Amended) An item of jewelry comprising a main body having an inlay area ~~inlaid portion~~ of concaved shape and a ~~decorating part attached~~ secured in to said inlay area ~~inlaid portion~~; wherein said decorating part is composed of a copper alloy which contains 6 to 15 weight percentage of copper and 94 to 85 weight percentage of gold; said item of jewelry being secured in said inlay area by a layer of solder in said inlay area between said decorative part and said main body.

2. (Currently Amended) The item of jewelry ~~A jewelry~~ as claimed in Claim 1, wherein said jewelry are has a ~~formed in curved~~ curved surface at foresaid ~~inlaid portion area~~ ~~of foresaid decorating part.~~

3. (Currently Amended) The item of jewelry ~~A jewelry~~ as claimed in Claim 1, wherein said jewelry is selected from group of jewelry including rings, pendants, necklaces, earrings, cuff buttons, brooches, tie tacks, bangles, buckles, chokers, bracelets, watch band and glasses.

4. (Withdrawn) A method of manufacturing jewelry including steps of forming a main body having inlaid portion of concaved shape, of forming an decorating part into made of copper alloy containing 6 to 15 weight percentage of copper and 94 to

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85 weight percentage of gold, of applying flux joint surfaces main body and/or an decorating part, of inserting said decorating part in said inlaid portion, of soldering surfaces of border of main body and decorating parts.

5. (Withdrawn) A method of cleaning jewelry in Claim 1, wherein polishing process is applied on surface of decorating part after certain time of use.

6. (New) The item of jewelry of claim 1 wherein said main body is made of a metal chosen from the group consisting of a gold alloy, a silver alloy, a platinum alloy, and combinations thereof.

7. (New) The item of jewelry of claim 1 wherein said item of jewelry includes a flux applied to said main body and/or said decorating part prior to the insertion of said decorating part in said inlay area and solder placed about said decorating part at a junction of said decorating part and said main body; said layer of solder being formed by applying heat to said item of jewelry; whereby, under heat, the flux evaporates forming a gap between said decorating item and said main body and said solder is pulled into said gap to form said layer of solder.

8. (New) An item of jewelry comprising a main body having an inlay area of concaved shape and a decorating part secured in said inlay area; said decorating part being composed of a copper alloy which contains 6 to 15 weight percent copper and 94 to 85 weight percent gold; one or both of said decorating part and said inlay area being

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coated with a flux, such that said flux is positioned between said decorating part and a surface of said inlay area; said item of jewelry being secured in said inlay area by a layer of solder which replaces said flux under the influence of heat; said solder securing said decorating part in said main body inlay area.

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